

## C1210C272GATACTU

Aliases (C1210C272GATAC7800) SMD Comm X8G HT150C, Ceramic, 2,700 pF, 2%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



General Information		
Series	SMD Comm X8G HT150C	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable	
Features	High Temperature, Ultra-Stable	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	30 mg	
Shelf Life	78 Weeks	
MSL	1	

	Specifications	
210	Capacitance	2,700 pF
.2mm +/-0.2mm	Measurement Condition	1 kHz 1.0Vrms
.5mm +/-0.2mm	Tolerance	2%
.9mm +/-0.10mm	Voltage DC	250 VDC
5mm MIN	Dielectric Withstanding Voltage	625 VDC
.5mm +/-0.25mm	Temperature Range	-55/+150°C
	Temp. Coefficient	X8G
&R, 180mm, Plastic Tape 000	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
	Dissipation Factor	0.1% 1 kHz 1.0Vrms

Aging Rate

Insulation Resistance

Click here for the 3D model.

Dimensions	
Chip Size	1210
L	3.2mm +/-0.2mm
W	2.5mm +/-0.2mm
т	0.9mm +/-0.10mm
S	1.5mm MIN
В	0.5mm +/-0.25mm

## Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

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0% Loss/Decade Hour: Referee Time is 1000 Hours

100 GOhms